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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	224 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	18-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f628-20i-p

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TABLE 2-1: PIC16F62X PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0	RA0	ST	CMOS	Bi-directional I/O port
	AN0	AN	—	Analog comparator input
RA1/AN1	RA1	ST	CMOS	Bi-directional I/O port
	AN1	AN	—	Analog comparator input
RA2/AN2/VREF	RA2	ST	CMOS	Bi-directional I/O port
	AN2	AN	—	Analog comparator input
	VREF	—	AN	VREF output
RA3/AN3/CMP1	RA3	ST	CMOS	Bi-directional I/O port
	AN3	AN	—	Analog comparator input
	CMP1	—	CMOS	Comparator 1 output
RA4/T0CKI/CMP2	RA4	ST	OD	Bi-directional I/O port
	T0CKI	ST	—	Timer0 clock input
	CMP2	—	OD	Comparator 2 output
RA5/MCLR/VPP	RA5	ST	—	Input port
	MCLR	ST	—	Master clear
	VPP	—	—	Programming voltage input. When configured as MCLR, this pin is an active low RESET to the device. Voltage on MCLR/VPP must not exceed VDD during normal device operation.
RA6/OSC2/CLKOUT	RA6	ST	CMOS	Bi-directional I/O port
	OSC2	XTAL	—	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
	CLKOUT	—	CMOS	In ER/INTRC mode, OSC2 pin can output CLKOUT, which has 1/4 the frequency of OSC1
RA7/OSC1/CLKIN	RA7	ST	CMOS	Bi-directional I/O port
	OSC1	XTAL	—	Oscillator crystal input
	CLKIN	ST	—	External clock source input. ER biasing pin.
RB0/INT	RB0	TTL	CMOS	Bi-directional I/O port. Can be software programmed for internal weak pull-up.
	INT	ST	—	External interrupt.
RB1/RX/DT	RB1	TTL	CMOS	Bi-directional I/O port. Can be software programmed for internal weak pull-up.
	RX	ST	—	USART receive pin
	DT	ST	CMOS	Synchronous data I/O.
RB2/TX/CK	RB2	TTL	CMOS	Bi-directional I/O port.
	TX	—	CMOS	USART transmit pin
	CK	ST	CMOS	Synchronous clock I/O. Can be software programmed for internal weak pull-up.
RB3/CCP1	RB3	TTL	CMOS	Bi-directional I/O port. Can be software programmed for internal weak pull-up.
	CCP1	ST	CMOS	Capture/Compare/PWM I/O

Legend: O = Output
 — = Not used
 TTL = TTL Input

CMOS = CMOS Output
 I = Input
 OD = Open Drain Output

P = Power
 ST = Schmitt Trigger Input
 AN = Analog

PIC16F62X

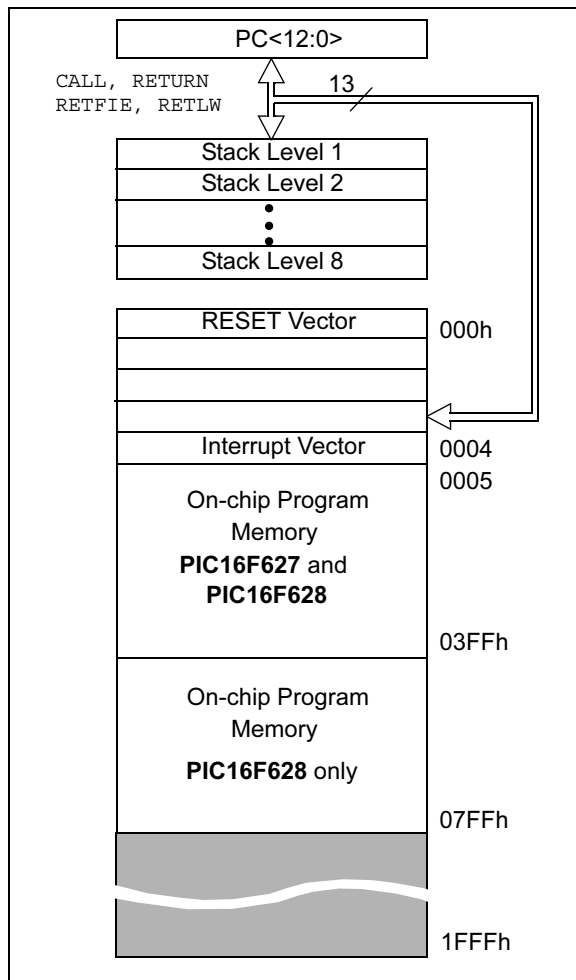
NOTES:

3.0 MEMORY ORGANIZATION

3.1 Program Memory Organization

The PIC16F62X has a 13-bit program counter capable of addressing an 8K x 14 program memory space. Only the first 1K x 14 (0000h - 03FFh) for the PIC16F627 and 2K x 14 (0000h - 07FFh) for the PIC16F628 are physically implemented. Accessing a location above these boundaries will cause a wrap-around within the first 1K x 14 space (PIC16F627) or 2K x 14 space (PIC16F628). The RESET vector is at 0000h and the interrupt vector is at 0004h (Figure 3-1).

FIGURE 3-1: PROGRAM MEMORY MAP AND STACK



3.2 Data Memory Organization

The data memory (Figure 3-2) is partitioned into four banks, which contain the general purpose registers and the Special Function Registers (SFR). The SFR's are located in the first 32 locations of each Bank. Register locations 20-7Fh, A0h-FFh, 120h-14Fh, 170h-17Fh and 1F0h-1FFh are general purpose registers implemented as static RAM.

The Table below lists how to access the four banks of registers:

	RP1	RP0
Bank0	0	0
Bank1	0	1
Bank2	1	0
Bank3	1	1

Addresses F0h-FFh, 170h-17Fh and 1F0h-1FFh are implemented as common RAM and mapped back to addresses 70h-7Fh.

3.2.1 GENERAL PURPOSE REGISTER FILE

The register file is organized as 224 x 8 in the PIC16F62X. Each is accessed either directly or indirectly through the File Select Register FSR (See Section 3.4).

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TABLE 3-2: SPECIAL FUNCTION REGISTERS SUMMARY BANK 1

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset ⁽¹⁾	Details on Page
Bank 1											
80h	INDF	Addressing this location uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	25
81h	OPTION	RBPV	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	20
82h	PCL	Program Counter's (PC) Least Significant Byte								0000 0000	25
83h	STATUS	IRP	RP1	RP0	T0	PD	Z	DC	C	0001 1xxx	19
84h	FSR	Indirect data memory address pointer								xxxx xxxx	25
85h	TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111	29
86h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111	34
87h	—	Unimplemented								—	—
88h	—	Unimplemented								—	—
89h	—	Unimplemented								—	—
8Ah	PCLATH	—	—	—	Write buffer for upper 5 bits of program counter					---0 0000	25
8Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	21
8Ch	PIE1	EEIE	CMIE	RCIE	TXIE	—	CCP1IE	TMR2IE	TMR1IE	0000 -000	22
8Dh	—	Unimplemented								—	—
8Eh	PCON	—	—	—	—	OSCF	—	POR	BOD	---- 1-0x	24
8Fh	—	Unimplemented								—	—
90h	—	Unimplemented								—	—
91h	—	Unimplemented								—	—
92h	PR2	Timer2 Period Register								1111 1111	50
93h	—	Unimplemented								—	—
94h	—	Unimplemented								—	—
95h	—	Unimplemented								—	—
96h	—	Unimplemented								—	—
97h	—	Unimplemented								—	—
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	69
99h	SPBRG	Baud Rate Generator Register								0000 0000	69
9Ah	EEDATA	EEPROM data register								xxxx xxxx	87
9Bh	EEADR	—	EEPROM address register							xxxx xxxx	87
9Ch	EECON1	—	—	—	—	WRERR	WREN	WR	RD	---- x000	87
9Dh	EECON2	EEPROM control register 2 (not a physical register)								-----	87
9Eh	—	Unimplemented								—	—
9Fh	VRCON	VREN	VROE	VRR	—	VR3	VR2	VR1	VR0	000- 0000	59

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

Note 1: For the Initialization Condition for Registers Tables, refer to Table 14-7 and Table 14-8 on page 98.

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7.0 TIMER1 MODULE

The Timer1 module is a 16-bit timer/counter consisting of two 8-bit registers (TMR1H and TMR1L) which are readable and writable. The TMR1 Register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The TMR1 Interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit TMR1IF (PIR1<0>). This interrupt can be enabled/disabled by setting/clearing TMR1 interrupt enable bit TMR1IE (PIE1<0>).

Timer1 can operate in one of two modes:

- As a timer
- As a counter

The Operating mode is determined by the clock select bit, TMR1CS (T1CON<1>).

In Timer mode, Timer1 increments every instruction cycle. In Counter mode, it increments on every rising edge of the external clock input.

Timer1 can be enabled/disabled by setting/clearing control bit TMR1ON (T1CON<0>).

Timer1 also has an internal "RESET input". This RESET can be generated by the CCP module (Section 11.0). Register 7-1 shows the Timer1 Control register.

For the PIC16F627 and PIC16F628, when the Timer1 oscillator is enabled (T1OSCEN is set), the RB7/T1OSI and RB6/T1OSO/T1CKI pins become inputs. That is, the TRISB<7:6> value is ignored.

REGISTER 7-1: T1CON: TIMER1 CONTROL REGISTER (ADDRESS: 10h)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNCR	TMR1CS	TMR1ON

bit 7

bit 0

bit 7-6 **Unimplemented:** Read as '0'

bit 5-4 **T1CKPS1:T1CKPS0:** Timer1 Input Clock Prescale Select bits

11 = 1:8 Prescale value

10 = 1:4 Prescale value

01 = 1:2 Prescale value

00 = 1:1 Prescale value

bit 3 **T1OSCEN:** Timer1 Oscillator Enable Control bit

1 = Oscillator is enabled

0 = Oscillator is shut off⁽¹⁾

bit 2 **T1SYNCR:** Timer1 External Clock Input Synchronization Control bit

TMR1CS = 1

1 = Do not synchronize external clock input

0 = Synchronize external clock input

TMR1CS = 0

This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.

bit 1 **TMR1CS:** Timer1 Clock Source Select bit

1 = External clock from pin RB6/T1OSO/T1CKI (on the rising edge)

0 = Internal clock (Fosc/4)

bit 0 **TMR1ON:** Timer1 On bit

1 = Disables Timer1

0 = Stops Timer1

Note 1: The oscillator inverter and feedback resistor are turned off to eliminate power drain.

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

10.0 VOLTAGE REFERENCE MODULE

The Voltage Reference is a 16-tap resistor ladder network that provides a selectable voltage reference. The resistor ladder is segmented to provide two ranges of VREF values and has a power-down function to conserve power when the reference is not being used. The VRCON register controls the operation of the reference as shown in Figure 10-1. The block diagram is given in Figure 10-1.

10.1 Configuring the Voltage Reference

The Voltage Reference can output 16 distinct voltage levels for each range.

The equations used to calculate the output of the Voltage Reference are as follows:

$$\text{if } VRR = 1: VREF = (VR<3:0>/24) \times VDD$$

$$\text{if } VRR = 0: VREF = (VDD \times 1/4) + (VR<3:0>/32) \times VDD$$

The setting time of the Voltage Reference must be considered when changing the VREF output (Table 17-2). Example 10-1 shows an example of how to configure the Voltage Reference for an output voltage of 1.25V with VDD = 5.0V.

REGISTER 10-1: VRCON REGISTER (ADDRESS: 9Fh)

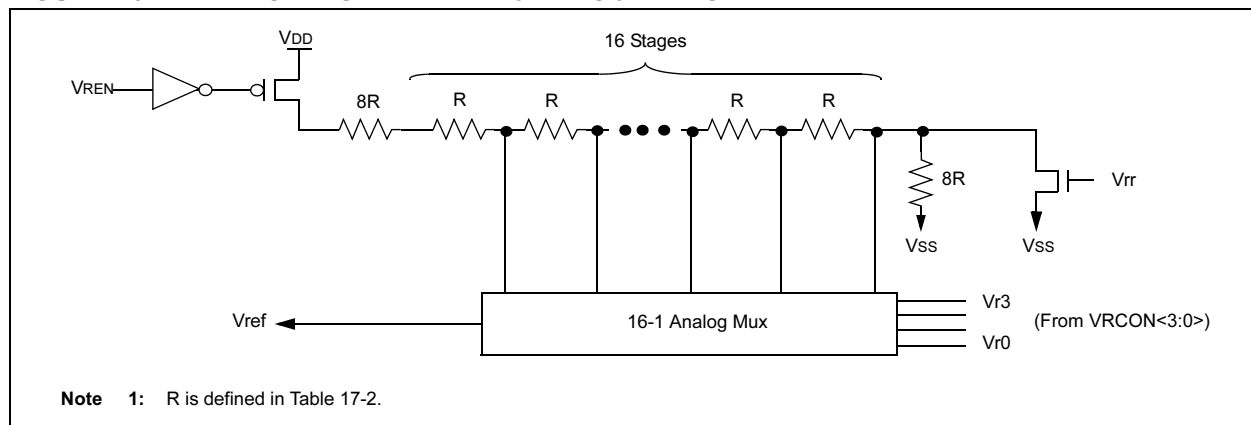
R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
VREN	VROE	VRR	—	VR3	VR2	VR1	VR0
bit 7							bit 0

- bit 7 **VREN:** VREF Enable
 1 = VREF circuit powered on
 0 = VREF circuit powered down, no IDD drain
- bit 6 **VROE:** VREF Output Enable
 1 = VREF is output on RA2 pin
 0 = VREF is disconnected from RA2 pin
- bit 5 **VRR:** VREF Range selection
 1 = Low Range
 0 = High Range
- bit 4 **Unimplemented:** Read as '0'
- bit 3-0 **VR<3:0>:** VREF value selection $0 \leq VR [3:0] \leq 15$
 When VRR = 1: $VREF = (VR<3:0>/24) \times VDD$
 When VRR = 0: $VREF = 1/4 \times VDD + (VR<3:0>/32) \times VDD$

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared
		x = Bit is unknown

FIGURE 10-1: VOLTAGE REFERENCE BLOCK DIAGRAM



PIC16F62X

REGISTER 12-2: RCSTA: RECEIVE STATUS AND CONTROL REGISTER (ADDRESS: 18h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0	R-x
SPEN	RX9	SREN	CREN	ADEN	FERR	OERR	RX9D
bit 7							bit 0

- bit 7 **SPEN**: Serial Port Enable bit
(Configures RB1/RX/DT and RB2/TX/CK pins as serial port pins when bits TRISB<2:17> are set)
1 = Serial port enabled
0 = Serial port disabled
- bit 6 **RX9**: 9-bit Receive Enable bit
1 = Selects 9-bit reception
0 = Selects 8-bit reception
- bit 5 **SREN**: Single Receive Enable bit
Asynchronous mode:
Don't care
Synchronous mode - master:
1 = Enables single receive
0 = Disables single receive
This bit is cleared after reception is complete.
Synchronous mode - slave:
Unused in this mode
- bit 4 **CREN**: Continuous Receive Enable bit
Asynchronous mode:
1 = Enables continuous receive
0 = Disables continuous receive
Synchronous mode:
1 = Enables continuous receive until enable bit CREN is cleared (CREN overrides SREN)
0 = Disables continuous receive
- bit 3 **ADEN**: Address Detect Enable bit
Asynchronous mode 9-bit (RX9 = 1):
1 = Enables address detection, enable interrupt and load of the receive buffer when RSR<8> is set
0 = Disables address detection, all bytes are received, and ninth bit can be used as PARITY bit
Asynchronous mode 8-bit (RX9=0):
Unused in this mode
Synchronous mode
Unused in this mode
- bit 2 **FERR**: Framing Error bit
1 = Framing error (Can be updated by reading RCREG register and receive next valid byte)
0 = No framing error
- bit 1 **OERR**: Overrun Error bit
1 = Overrun error (Can be cleared by clearing bit CREN)
0 = No overrun error
- bit 0 **RX9D**: 9th bit of received data (Can be PARITY bit)

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared x = Bit is unknown

14.5 Power-on Reset (POR), Power-up Timer (PWRT), Oscillator Start-up Timer (OST) and Brown-out Detect (BOD)

14.5.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in RESET until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the MCLR pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

The POR circuit does not produce an internal RESET when VDD declines.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting".

14.5.2 POWER-UP TIMER (PWRT)

The PWRT provides a fixed 72 ms (nominal) timeout on power-up only, from POR or Brown-out Detect Reset. The PWRT operates on an internal RC oscillator. The chip is kept in RESET as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, **PWRT**, can disable (if set) or enable (if cleared or programmed) the PWRT. The PWRT should always be enabled when Brown-out Detect Reset is enabled.

The Power-Up Time delay will vary from chip to chip and due to VDD, temperature and process variation. See DC parameters for details.

14.5.3 OSCILLATOR START-UP TIMER (OST)

The OST provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST timeout is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

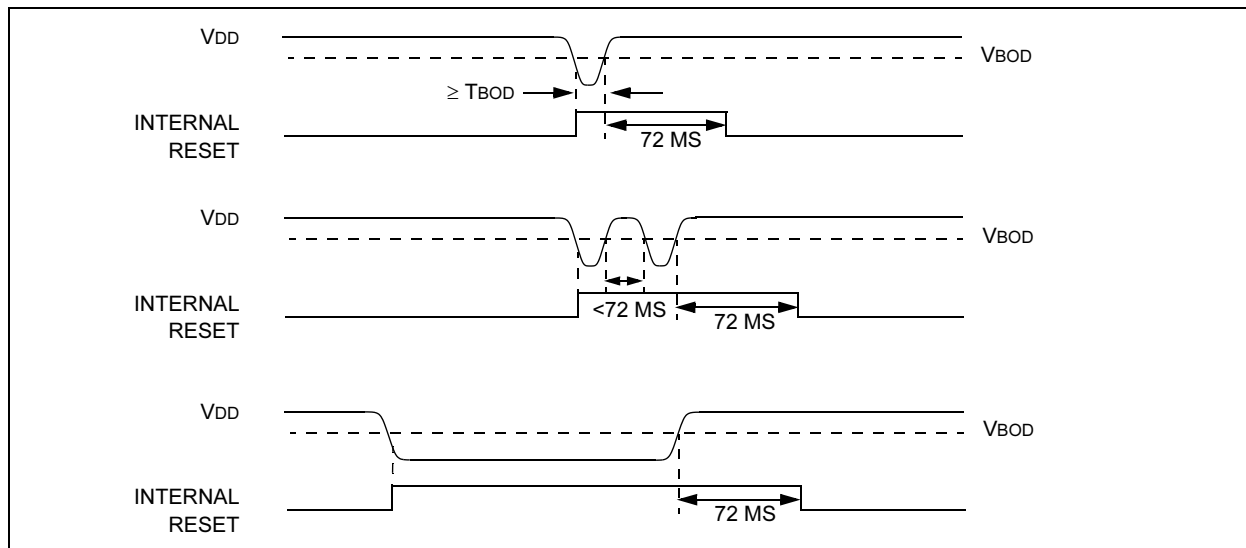
14.5.4 BROWN-OUT DETECT (BOD) RESET

The PIC16F62X members have on-chip BOD circuitry. A configuration bit, **BODEN**, can disable (if clear/programmed) or enable (if set) the BOD Reset circuitry. If VDD falls below VBOD for longer than TBOD, the brown-out situation will RESET the chip. A RESET is not guaranteed to occur if VDD falls below VBOD for shorter than TBOD. VBOD and TBOD are defined in Table 17-1 and Table 17-6, respectively.

On any RESET (Power-on, Brown-out, Watchdog, etc.) the chip will remain in RESET until VDD rises above VBOD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms.

If VDD drops below VBOD while the Power-up Timer is running, the chip will go back into a Brown-out Detect Reset and the Power-up Timer will be re-initialized. Once VDD rises above VBOD, the Power-Up Timer will execute a 72 ms RESET. The Power-up Timer should always be enabled when Brown-out Detect is enabled. Figure 14-7 shows typical Brown-out situations.

FIGURE 14-7: BROWN-OUT SITUATIONS



14.5.5 TIMEOUT SEQUENCE

On power-up the timeout sequence is as follows: First PWRT timeout is invoked after POR has expired. Then OST is activated. The total timeout will vary based on oscillator configuration and PWRTE bit status. For example, in ER mode with PWRTE bit erased (PWRT disabled), there will be no timeout at all. Figure 14-8, Figure 14-9 and Figure 14-10 depict timeout sequences.

Since the timeouts occur from the POR pulse, if $\overline{\text{MCLR}}$ is kept low long enough, the timeouts will expire. Then bringing $\overline{\text{MCLR}}$ high will begin execution immediately (see Figure 14-9). This is useful for testing purposes or to synchronize more than one PIC16F62X device operating in parallel.

Table 14-7 shows the RESET conditions for some special registers, while Table 14-8 shows the RESET conditions for all the registers.

14.5.6 POWER CONTROL (PCON) STATUS REGISTER

The Power Control/STATUS register, PCON (address 8Eh) has two bits.

Bit0 is $\overline{\text{BOD}}$ (Brown-out). $\overline{\text{BOD}}$ is unknown on Power-on Reset. It must then be set by the user and checked on subsequent RESETS to see if $\overline{\text{BOD}} = 0$ indicating that a brown-out has occurred. The $\overline{\text{BOD}}$ STATUS bit is a don't care and is not necessarily predictable if the brown-out circuit is disabled (by setting BODEN bit = 0 in the Configuration word).

Bit1 is $\overline{\text{POR}}$ (Power-on Reset). It is a '0' on Power-on Reset and unaffected otherwise. The user must write a '1' to this bit following a Power-on Reset. On a subsequent RESET if $\overline{\text{POR}}$ is '0', it will indicate that a Power-on Reset must have occurred (VDD may have gone too low).

TABLE 14-4: TIMEOUT IN VARIOUS SITUATIONS

Oscillator Configuration	Power-up		Brown-out Detect Reset	Wake-up from SLEEP
	$\overline{\text{PWRTE}} = 0$	$\overline{\text{PWRTE}} = 1$		
XT, HS, LP	72 ms + 1024 TOSC	1024 TOSC	72 ms + 1024 TOSC	1024 TOSC
ER, INTRC, EC	72 ms	—	72 ms	—

TABLE 14-5: STATUS/PCON BITS AND THEIR SIGNIFICANCE

$\overline{\text{POR}}$	$\overline{\text{BOD}}$	$\overline{\text{TO}}$	$\overline{\text{PD}}$	
0	X	1	1	Power-on Reset
0	X	0	X	Illegal, $\overline{\text{TO}}$ is set on $\overline{\text{POR}}$
0	X	X	0	Illegal, $\overline{\text{PD}}$ is set on $\overline{\text{POR}}$
1	0	X	X	Brown-out Detect Reset
1	1	0	u	WDT Reset
1	1	0	0	WDT Wake-up
1	1	u	u	$\overline{\text{MCLR}}$ Reset during normal operation
1	1	1	0	$\overline{\text{MCLR}}$ Reset during SLEEP

Legend: u = unchanged, x = unknown.

TABLE 14-6: SUMMARY OF REGISTERS ASSOCIATED WITH BROWN-OUT

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other RESETS ⁽¹⁾
03h	STATUS	IRP	RP1	RPO	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	0001 1xxx	000q quuu
8Eh	PCON	—	—	—	—	OSCF	Reset	$\overline{\text{POR}}$	$\overline{\text{BOD}}$	---- 1-0x	---- u-uq

Note 1: Other (non Power-up) Resets include $\overline{\text{MCLR}}$ Reset, Brown-out Detect Reset and Watchdog Timer Reset during normal operation.

TABLE 14-9: SUMMARY OF INTERRUPT REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other RESETS ⁽¹⁾
0Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	EEIF	CMIF	RCIF	TXIF	—	CCP1IF	TMR2IF	TMR1IF	0000 -000	0000 -000
8Ch	PIE1	EEIE	CMIE	RCIE	TXIE	—	CCP1IE	TMR2IE	TMR1IE	0000 -000	0000 -000

Note 1: Other (non Power-up) Resets include MCLR Reset, Brown-out Detect Reset and Watchdog Timer Reset during normal operation.

14.7 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt (e.g., W register and STATUS register). This will have to be implemented in software.

Example 14-2 stores and restores the STATUS and W registers. The user register, W_TEMP, must be defined in a common memory location (i.e., W_TEMP is defined at 0x70 in Bank 0 and is therefore, accessible at 0xF0, 0x17 and 0x1FD). The Example 14-2:

- Stores the W register
- Stores the STATUS register
- Executes the ISR code
- Restores the STATUS (and bank select bit register)
- Restores the W register

EXAMPLE 14-2: SAVING THE STATUS AND W REGISTERS IN RAM

```

MOVWF  W_TEMP      ;copy W to temp register,
                    ;could be in either bank

SWAPF  STATUS,W     ;swap status to be saved
                    ;into W

BCF     STATUS,RP0   ;change to bank 0 regardless
                    ;of current bank

MOVWF  STATUS_TEMP  ;save status to bank 0
                    ;register

:
: (ISR)
:

SWAPF  STATUS_TEMP,W ;swap STATUS_TEMP register
                    ;into W, sets bank to origi-
                    ;nal
                    ;state

MOVWF  STATUS       ;move W into STATUS register

SWAPF  W_TEMP,F     ;swap W_TEMP

SWAPF  W_TEMP,W     ;swap W_TEMP into W

```

14.8 Watchdog Timer (WDT)

The Watchdog Timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the ER oscillator of the CLKIN pin. That means that the WDT will run, even if the clock on the OSC1 and OSC2 pins of the device has been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT timeout generates a device RESET. If the device is in SLEEP mode, a WDT timeout causes the device to wake-up and continue with normal operation. The WDT can be permanently disabled by programming the configuration bit WDTE as clear (Section 14.1).

14.8.1 WDT PERIOD

The WDT has a nominal timeout period of 18 ms (with no prescaler). The timeout periods vary with temperature, VDD and process variations from part to part (see DC specs). If longer timeout periods are desired, a postscaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION register. Thus, timeout periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET.

The $\overline{\text{TO}}$ bit in the STATUS register will be cleared upon a Watchdog Timer timeout.

14.8.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler), it may take several seconds before a WDT timeout occurs.

PIC16F62X

14.12 In-Circuit Serial Programming

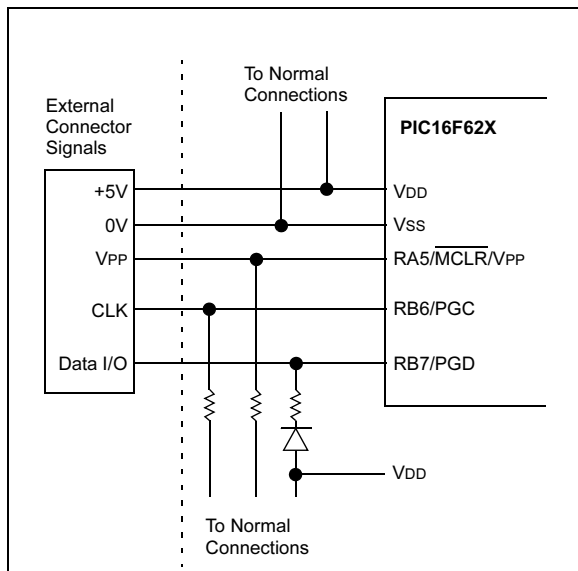
The PIC16F62X microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware, or a custom firmware to be programmed.

The device is placed into a Program/Verify mode by holding the RB6 and RB7 pins low while raising the MCLR (VPP) pin from VIL to VIH (see programming specification). RB6 becomes the programming clock and RB7 becomes the programming data. Both RB6 and RB7 are Schmitt Trigger inputs in this mode.

After RESET, to place the device into Programming/Verify mode, the program counter (PC) is at location 00h. A 6-bit command is then supplied to the device. Depending on the command, 14 bits of program data are then supplied to or from the device, depending if the command was a load or a read. For complete details of serial programming, please refer to the Programming Specifications.

A typical in-circuit serial programming connection is shown in Figure 14-18.

FIGURE 14-18: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING CONNECTION



14.13 Low Voltage Programming

The LVP bit of the configuration word, enables the low voltage programming. This mode allows the microcontroller to be programmed via ICSP using only a 5V source. This mode removes the requirement of VIH on the MCLR pin. The LVP bit is normally erased to '1', which enables the low voltage programming. In this mode, the RB4/PGM pin is dedicated to the programming function and ceases to be a general purpose I/O pin. The device will enter Programming mode when a '1' is placed on the RB4/PGM pin. The HV Programming mode is still available by placing VIH on the MCLR pin.

Note 1: While in this mode, the RB4 pin can no longer be used as a general purpose I/O pin.

2: VDD must be 5.0V \pm 10% during erase/program operations while in low voltage Programming mode.

If Low voltage Programming mode is not used, the LVP bit can be programmed to a '0', and RB4/PGM becomes a digital I/O pin. To program the device, VIH must be placed onto MCLR during programming. The LVP bit may only be programmed when programming is entered with VIH on MCLR. The LVP bit cannot be programmed when programming is entered with RB4/PGM.

It should be noted, that once the LVP bit is programmed to 0, High voltage Programming mode can be used to program the device.

15.0 INSTRUCTION SET SUMMARY

Each PIC16F62X instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16F62X instruction set summary in Table 15-2 lists byte-oriented, bit-oriented, and literal and control operations. Table 15-1 shows the opcode field descriptions.

For byte-oriented instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For bit-oriented instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For literal and control operations, 'k' represents an eight or eleven bit constant or literal value.

TABLE 15-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1
label	Label name
TOS	Top of Stack
PC	Program Counter
PCLA	Program Counter High Latch
TH	
GIE	Global Interrupt Enable bit
WDT	Watchdog Timer/Counter
TO	Timeout bit
PD	Power-down bit
dest	Destination either the W register or the specified register file location
[]	Options
()	Contents
→	Assigned to
< >	Register bit field
∈	In the set of
italics	User defined term (font is courier)

The instruction set is highly orthogonal and is grouped into three basic categories:

- **Byte-oriented** operations
- **Bit-oriented** operations
- **Literal and control** operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μs. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μs.

Table 15-2 lists the instructions recognized by the MPASM™ assembler.

Figure 15-1 shows the three general formats that the instructions can have.

Note 1: Any unused opcode is reserved. Use of any reserved opcode may cause unexpected operation.

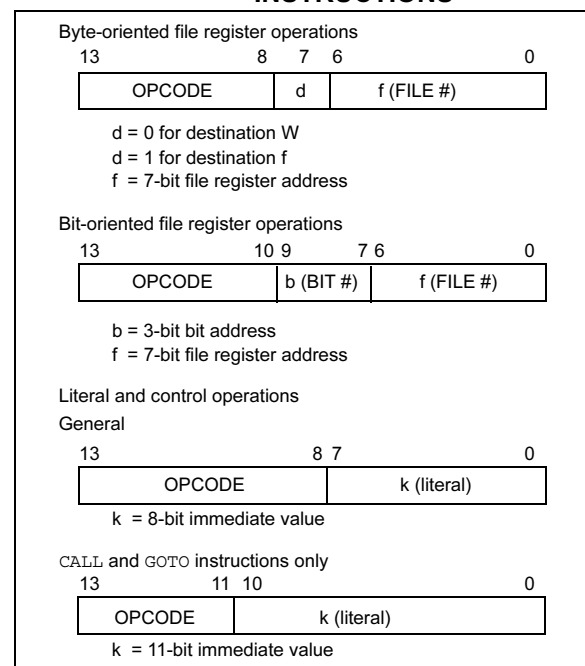
2: To maintain upward compatibility with future PICmicro® products, do not use the OPTION and TRIS instructions.

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

FIGURE 15-1: GENERAL FORMAT FOR INSTRUCTIONS



16.14 PICDEM 1 PICmicro Demonstration Board

The PICDEM 1 demonstration board demonstrates the capabilities of the PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The sample microcontrollers provided with the PICDEM 1 demonstration board can be programmed with a PRO MATE II device programmer, or a PICSTART Plus development programmer. The PICDEM 1 demonstration board can be connected to the MPLAB ICE in-circuit emulator for testing. A prototype area extends the circuitry for additional application components. Features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs.

16.15 PICDEM.net Internet/Ethernet Demonstration Board

The PICDEM.net demonstration board is an Internet/Ethernet demonstration board using the PIC18F452 microcontroller and TCP/IP firmware. The board supports any 40-pin DIP device that conforms to the standard pinout used by the PIC16F877 or PIC18C452. This kit features a user friendly TCP/IP stack, web server with HTML, a 24L256 Serial EEPROM for Xmodem download to web pages into Serial EEPROM, ICSP/MPLAB ICD 2 interface connector, an Ethernet interface, RS-232 interface, and a 16 x 2 LCD display. Also included is the book and CD-ROM *"TCP/IP Lean, Web Servers for Embedded Systems,"* by Jeremy Bentham

16.16 PICDEM 2 Plus Demonstration Board

The PICDEM 2 Plus demonstration board supports many 18-, 28-, and 40-pin microcontrollers, including PIC16F87X and PIC18FXX2 devices. All the necessary hardware and software is included to run the demonstration programs. The sample microcontrollers provided with the PICDEM 2 demonstration board can be programmed with a PRO MATE II device programmer, PICSTART Plus development programmer, or MPLAB ICD 2 with a Universal Programmer Adapter. The MPLAB ICD 2 and MPLAB ICE in-circuit emulators may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area extends the circuitry for additional application components. Some of the features include an RS-232 interface, a 2 x 16 LCD display, a piezo speaker, an on-board temperature sensor, four LEDs, and sample PIC18F452 and PIC16F877 FLASH microcontrollers.

16.17 PICDEM 3 PIC16C92X Demonstration Board

The PICDEM 3 demonstration board supports the PIC16C923 and PIC16C924 in the PLCC package. All the necessary hardware and software is included to run the demonstration programs.

16.18 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. A programmed sample is included. The PRO MATE II device programmer, or the PICSTART Plus development programmer, can be used to reprogram the device for user tailored application development. The PICDEM 17 demonstration board supports program download and execution from external on-board FLASH memory. A generous prototype area is available for user hardware expansion.

PIC16F62X

TABLE 17-4: EXTERNAL CLOCK TIMING REQUIREMENTS

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
	Fosc	External CLKIN Frequency ⁽¹⁾	DC	—	4	MHz	XT and ER Osc mode, VDD = 5.0V
			DC	—	20	MHz	HS Osc mode
			DC	—	200	kHz	LP Osc mode
		Oscillator Frequency ⁽¹⁾		—	4	MHz	ER Osc mode, VDD = 5.0V
			0.1	—	4	MHz	XT Osc mode
			1	—	20	MHz	HS Osc mode
				—	200	kHz	LP Osc mode
			3.65	4	4.28	MHz	INTRC mode (fast), VDD = 5.0V
				37		kHz	INTRC mode (slow)
4	INTRC	Internal Calibrated RC	3.65	4.00	4.28	MHz	VDD = 5.0V
5	ER	External Biased ER Frequency	10 kHz		8 MHz		VDD = 5.0V
1	Tosc	External CLKIN Period ⁽¹⁾	250	—	—	ns	XT and ER Osc mode
			50	—	—	ns	HS Osc mode
			5	—	—	μs	LP Osc mode
		Oscillator Period ⁽¹⁾	250	—	—	ns	ER Osc mode
			250	—	10,000	ns	XT Osc mode
			50	—	1,000	ns	HS Osc mode
			5			μs	LP Osc mode
				250		ns	INTRC mode (fast)
				27		μs	INTRC mode (slow)
2	Tcy	Instruction Cycle Time	1.0	Tcy	DC	ns	Tcy = 4/Fosc
3	TosL, TosH	External CLKIN (OSC1) High External CLKIN Low	100 *	—	—	ns	XT oscillator, TOSC L/H duty cycle*

* These parameters are characterized but not tested.

† Data in “Typ” column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (Tcy) equals four times the input oscillator time-based period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at “Min.” values with an external clock applied to the OSC1 pin. When an external clock input is used, the “Max” cycle time limit is “DC” (no clock) for all devices.

FIGURE 17-7: CLKOUT AND I/O TIMING

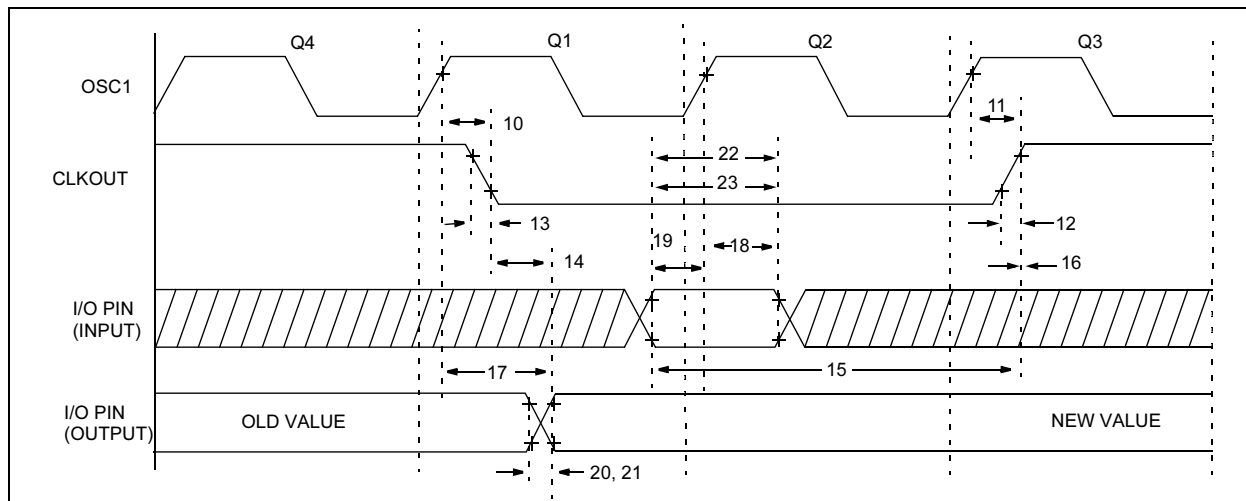


TABLE 17-5: CLKOUT AND I/O TIMING REQUIREMENTS

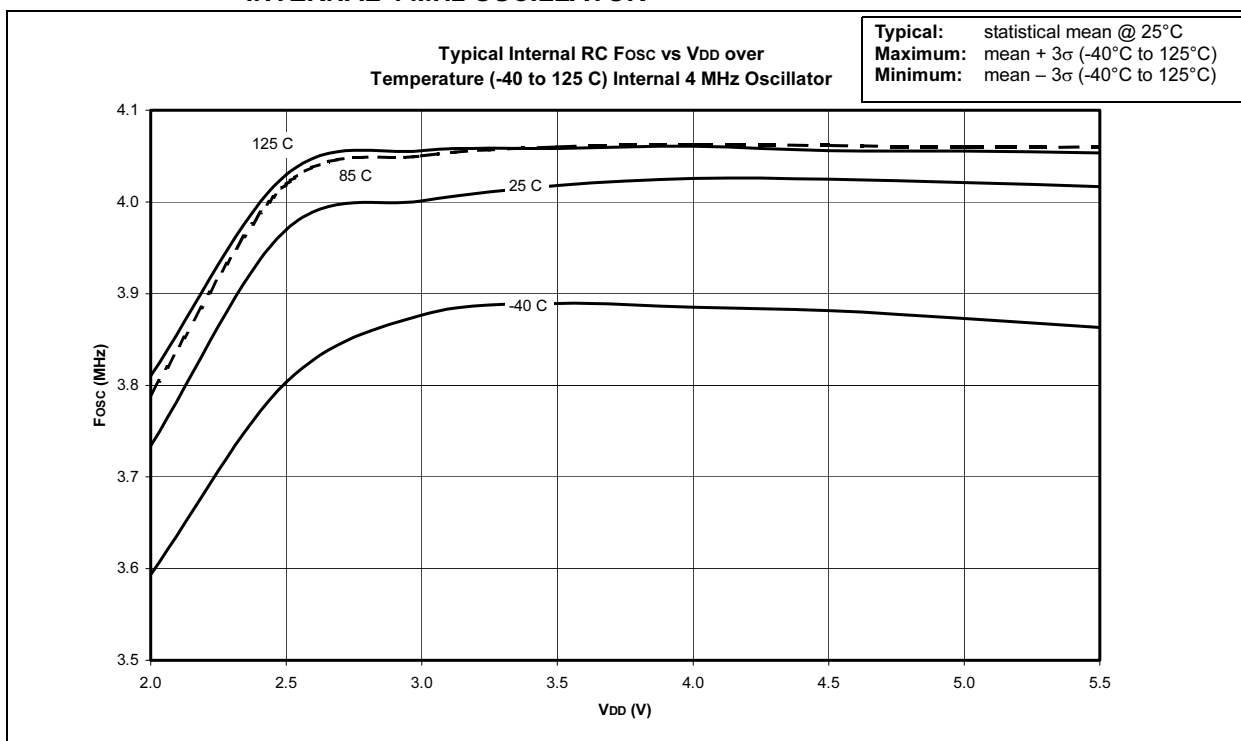
Param No.	Sym	Characteristic		Min	Typ†	Max	Units
10*	TosH2ckL	OSC1↑ to CLKOUT↓	16F62X	—	75	200	ns
10A*			16LF62X	—	—	400	ns
11*	TosH2ckH	OSC1↑ to CLKOUT↑	16F62X	—	75	200	ns
11A*			16LF62X	—	—	400	ns
12*	TckR	CLKOUT rise time	16F62X	—	35	100	ns
12A*			16LF62X	—	—	200	ns
13*	TckF	CLKOUT fall time	16F62X	—	35	100	ns
13A*			16LF62X	—	—	200	ns
14*	TckL2ioV	CLKOUT ↓ to Port out valid		—	—	20	ns
15*	TioV2ckH	Port in valid before CLKOUT ↑	16F62X	Tosc+200 ns	—	—	ns
			16LF62X	Tosc=400 ns	—	—	ns
16*	TckH2ioI	Port in hold after CLKOUT ↑		0	—	—	ns
17*	TosH2ioV	OSC1↑ (Q1 cycle) to Port out valid	16F62X	—	50	150*	ns
			16LF62X	—	—	300	ns
18*	TosH2ioI	OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time)		100 200	—	—	ns

* These parameters are characterized but not tested.

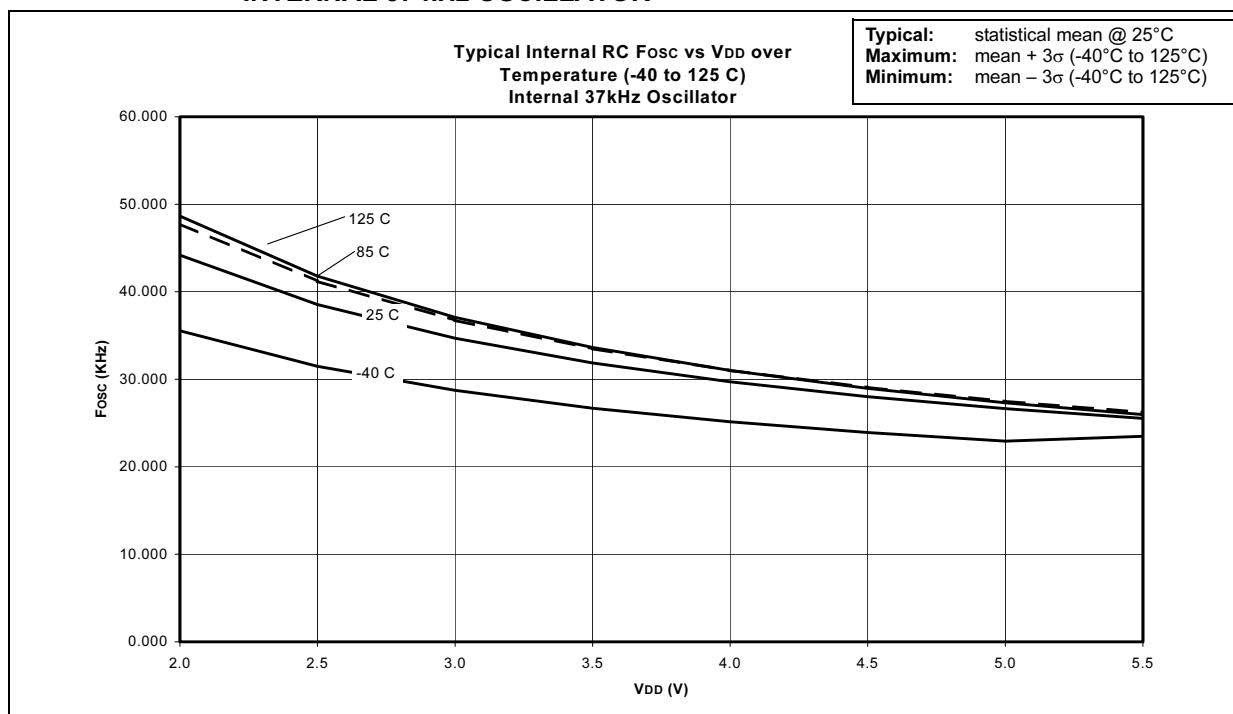
† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note: The graphs and tables provided in this section are for design guidance and are not tested.

**FIGURE 18-8: TYPICAL INTERNAL RC Fosc vs VDD TEMPERATURE (-40 TO 125°C)
INTERNAL 4 MHz OSCILLATOR**

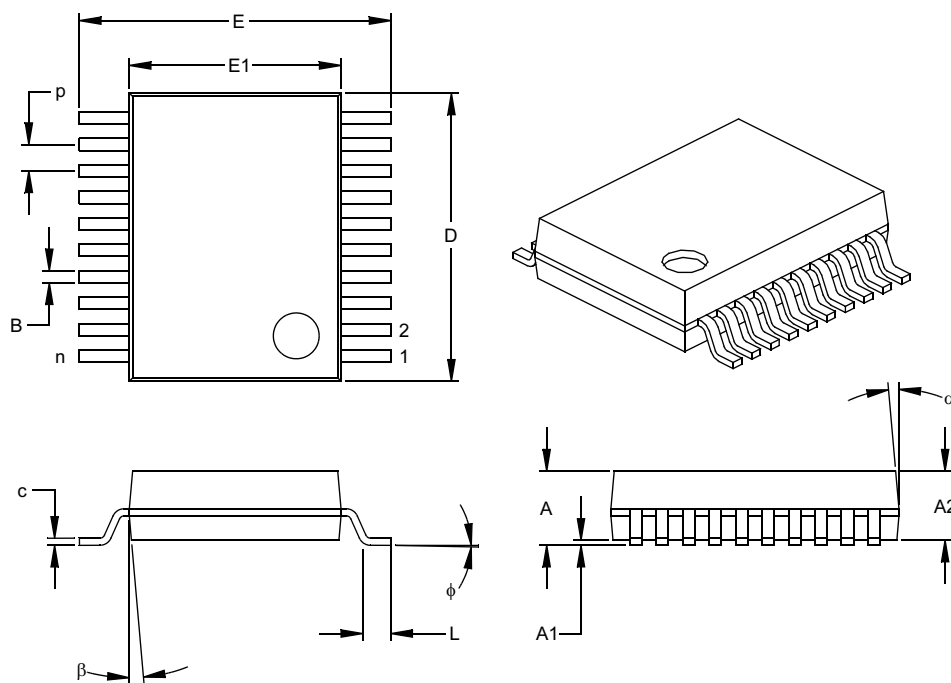


**FIGURE 18-9: TYPICAL INTERNAL RC Fosc vs VDD OVER TEMPERATURE (-40 TO 125°C)
INTERNAL 37 kHz OSCILLATOR**



PIC16F62X

K04-072 20-Lead Plastic Shrink Small Outline (SS) – 5.30 mm



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		20			20	
Pitch	p		.026			0.65	
Overall Height	A	.068	.073	.078	1.73	1.85	1.98
Molded Package Thickness	A2	.064	.068	.072	1.63	1.73	1.83
Standoff §	A1	.002	.006	.010	0.05	0.15	0.25
Overall Width	E	.299	.309	.322	7.59	7.85	8.18
Molded Package Width	E1	.201	.207	.212	5.11	5.25	5.38
Overall Length	D	.278	.284	.289	7.06	7.20	7.34
Foot Length	L	.022	.030	.037	0.56	0.75	0.94
Lead Thickness	c	.004	.007	.010	0.10	0.18	0.25
Foot Angle	φ	0	4	8	0.00	101.60	203.20
Lead Width	B	.010	.013	.015	0.25	0.32	0.38
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-150

Drawing No. C04-072

PIC16F62X

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